



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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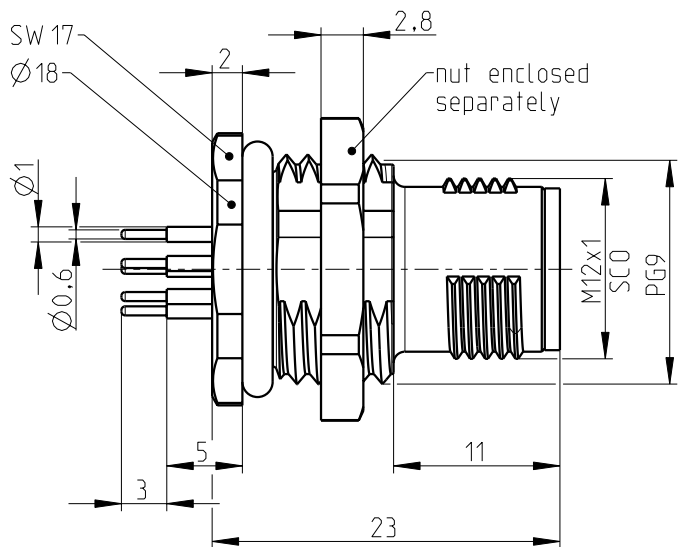
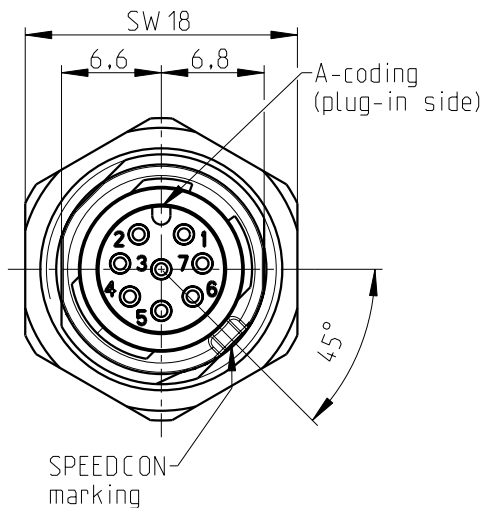
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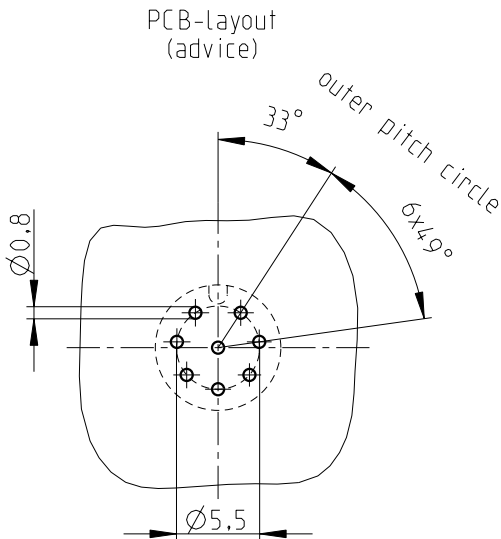
Mechanical data (according to IEC 61076-2-101)		Material	
no. of poles / coding	8 / A	housing / surface	GD-Zn / Ni
contact termination	dip solder / pin	contact carrier	PA 66 / UL 94 V0
contact-Ø	0.8mm	colour	black
temperature range	-40 °C / +85 °C	wire	-
protection class	IP 67	cross section	-
mating cycles	> 100	contacts / surface	CuZn / Au
locking system	M12 STANDARD / SPEEDCON	sealing gasket	FKM / NBR
		potting	-

further information:
- see technical data M12-1
- see installation recommendation PG9 design E

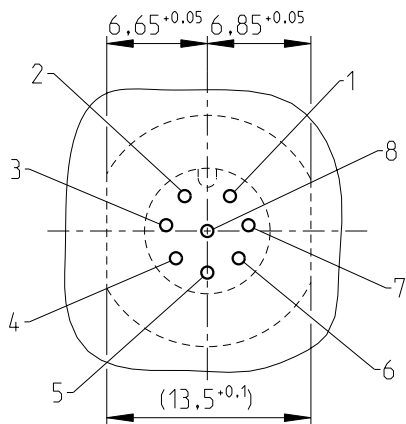



All specified data refers to the mounted M12 installation plugs ≥ IP54 and requires that the connector pair be correctly plugged and locked. Influences from wires, cables or PCB mounting are also to be taken into consideration.

View of pin assignment Plug-in side



Position PCB-layout
to cutout device



general tolerance acc. to DIN ISO 2768-c			technical changes reserved		Index 1 / 2012-04-30		scale: 2:1		
			description: Housing with dip solder contacts Rear mounting (PG9)					page: 1 of: 1	
design	date	name							
chk.									
			drawing-no.:		BA-08P2N22P000		doc.-no.:	00658750	
			order-no.:		1542758				
			article designation:		SACC-DSI-MS-8CON-L180 SCO				